

5'01

March 14, 2001 - Quiz #1

Name: SOLUTIONS

Recitation: \_\_\_\_\_

problem	grade
1	
2	
3	
4	
5	
6	
total	

General guidelines (please read carefully before starting):

- Make sure to write your name on the space designated above.
- **Open book:** you can use any material you wish.
- All answers should be given in the space provided. Please do not turn in any extra material. If you need more space, use the back page.
- You have **120 minutes** to complete your quiz.
- Make reasonable approximations and *state them*, i.e. quasi-neutrality, depletion approximation, etc.
- Partial credit will be given for setting up problems without calculations. **NO** credit will be given for answers without reasons.
- Use the symbols utilized in class for the various physical parameters, i.e.  $\mu_n$ ,  $I_D$ ,  $E$ , etc.
- Every numerical answer must have the proper units next to it. Points will be subtracted for answers without units or with wrong units.
- Use  $\phi = 0$  at  $n_o = p_o = n_i$  as potential reference.
- Use the following fundamental constants and physical parameters for silicon and silicon dioxide at room temperature:

$$\begin{aligned}
 n_i &= 1 \times 10^{10} \text{ cm}^{-3} \\
 kT/q &= 0.025 \text{ V} \\
 q &= 1.60 \times 10^{-19} \text{ C} \\
 \epsilon_s &= 1.05 \times 10^{-12} \text{ F/cm} \\
 \epsilon_{ox} &= 3.45 \times 10^{-13} \text{ F/cm}
 \end{aligned}$$

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1. (10 points) Compute the equilibrium electron and hole concentrations,  $n_0$  and  $p_0$ , for silicon at room temperature doped with:

(1a) (2 points) Boron (B) concentration =  $10^{17} \text{ cm}^{-3}$ .

p-type material with  $N_A = 10^{17} \text{ cm}^{-3}$

$$p_0 = 10^{17} \text{ cm}^{-3}$$

$$n_0 = 10^3 \text{ cm}^{-3}$$

(1b) (2 points) Phosphorus (P) concentration =  $5 \times 10^{16} \text{ cm}^{-3}$  and Antimony (Sb) concentration =  $5 \times 10^{16} \text{ cm}^{-3}$ .

Both n-type dopants, hence  $N_D = 5 \times 10^{16} + 5 \times 10^{16} = 10^{17} \text{ cm}^{-3}$

$$n_0 = 10^{17} \text{ cm}^{-3}$$

$$p_0 = 10^3 \text{ cm}^{-3}$$

(1c) (2 points) Arsenic (As) concentration =  $10^{17} \text{ cm}^{-3}$  and Boron (B) concentration =  $10^{16} \text{ cm}^{-3}$ .

Here there is some "compensation":

$$N_D = 10^{17} \text{ cm}^{-3}, N_A = 10^{16} \text{ cm}^{-3} \Rightarrow \text{effectively } N_D - N_A = 9 \times 10^{16} \text{ cm}^{-3}$$

$$n_0 = 9 \times 10^{16} \text{ cm}^{-3}$$

$$p_0 = 1.1 \times 10^3 \text{ cm}^{-3}$$

(1d) (4 points) In (1a) above, what is the magnitude of the electric field that must be applied to the sample for the magnitude of the majority carrier drift velocity to be equal to  $10^6 \text{ cm/s}$ ?

For p-type doping level of  $N_A = 10^{17} \text{ cm}^{-3}$ , the hole mobility is  $\mu_p \approx 350 \text{ cm}^2/\text{V}\cdot\text{s}$ . Since hole velocity is given by

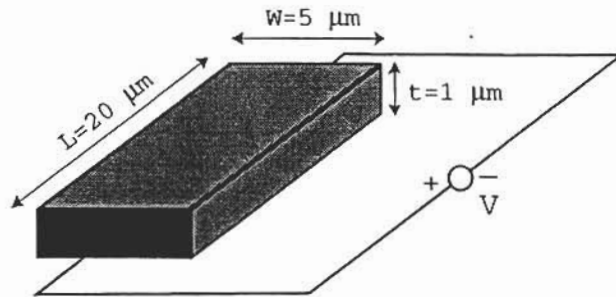
$$v_p = \mu_p E$$

then

$$E = \frac{v_p}{\mu_p} = \frac{10^6 \text{ cm/s}}{350 \text{ cm}^2/\text{V}\cdot\text{s}} = 2.9 \times 10^3 \text{ V/cm}$$

2. (10 points) An engineer is told that a region of silicon of length  $20 \mu\text{m}$ , width  $5 \mu\text{m}$  and thickness  $1 \mu\text{m}$  is uniformly doped with a single kind of dopant with a concentration of  $10^{20} \text{cm}^{-3}$ . Ohmic contacts are formed at the ends of the region and she measures the I-V characteristics given in the table below. Is the sample n-type or p-type? Explain how you reach this conclusion. [Hint: think about the sample resistance.] Sample is at room temperature.

voltage (V)	current (A)
0	0
1	0.025
2	0.05



From the I-V characteristics we can derive the resistance of the sample:

$$R = \frac{V}{I} = \frac{2 \text{ V}}{0.05 \text{ A}} = 40 \Omega$$

we can now derive the resistivity of the material since:

$$R = \rho \frac{L}{wt}$$

$\rho$  is

$$\rho = R \frac{wt}{L} = 40 \Omega \frac{5 \times 10^{-4} \text{ cm} \times 10^{-4} \text{ cm}}{20 \times 10^{-4} \text{ cm}} = 10^{-3} \Omega \cdot \text{cm}$$

Looking at the chart of resistivity vs. doping level, we see that for  $N_A = 10^{20} \text{cm}^{-3}$ , the resistivity of Si at room temperature is precisely  $10^{-3} \Omega \cdot \text{cm}$ . Hence, this is a p-type sample.

3. (10 points) In a certain n-type region of a semiconductor in thermal equilibrium, there is a hole concentration with the following spatial distribution:

$$p_0(x) = 10^3(1 - 9 \times 10^3 x) \text{ cm}^{-3} \quad \text{for } 0 \leq x \leq 10^{-4} \text{ with } x \text{ in cm}$$

Assume that in this region, the electron mobility and hole mobilities are  $\mu_n = 500 \text{ cm}^2/\text{V} \cdot \text{s}$  and  $\mu_p = 200 \text{ cm}^2/\text{V} \cdot \text{s}$ , respectively.

(3a.) (5 points) Derive an expression for and sketch the hole diffusion current density in this region.

Hole diffusion current density is given by:

$$J_p^{\text{diff}} = -q D_p \frac{dp_0}{dx}$$

$D_p$  can be obtained using Boltzmann relation:

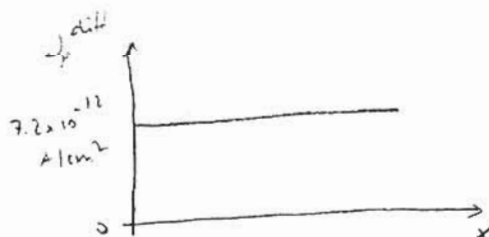
$$D_p = \frac{kT}{q} \mu_p = 0.025 \times 200 = 5 \text{ cm}^2/\text{s}$$

$\frac{dp_0}{dx}$  is given by

$$\frac{dp_0}{dx} = 10^3 (-9 \times 10^3) = -9 \times 10^6 \text{ cm}^{-4}$$

Then

$$J_p^{\text{diff}} = +1.6 \times 10^{-19} \text{ C} \times 5 \text{ cm}^2/\text{s} \times 9 \times 10^6 \text{ cm}^{-4} = 7.2 \times 10^{-12} \text{ A/cm}^2$$



(3b.) (5 points) Derive an expression for and sketch the electric field distribution in this region.

Since this is thermal equilibrium the sum of drift plus diffusion current must be zero. Then:

$$J_p = J_p^{\text{diff}} + J_p^{\text{drift}} = 0 \Rightarrow J_p^{\text{drift}} = -J_p^{\text{diff}}$$

The drift current is given by:

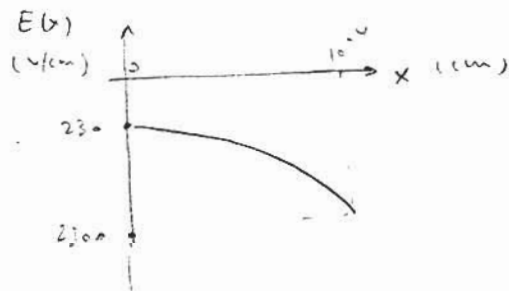
$$J_p^{\text{drift}} = q \mu_p p_0 E$$

Solving for  $E$ :

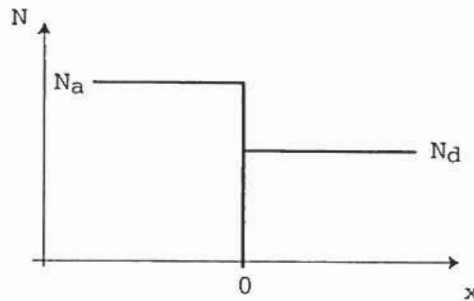
$$E = \frac{J_p^{\text{drift}}}{q \mu_p p_0} = - \frac{7.7 \times 10^{-12}}{1.6 \times 10^{-19} \times 200 \times 10^3 (1 - 9 \times 10^2 x)} = - \frac{2.3 \times 10^2}{1 - 9 \times 10^2 x} \text{ V/cm}$$

At  $x=0$  this gives  $E(0) = 270 \text{ V/cm}$ . At  $x = 10^{-4} \text{ cm}$ ,  $E(10^{-4} \text{ cm}) = 2300 \text{ V/cm}$

The electric field distribution looks like:



4. (20 points) Consider an abrupt pn junction with  $N_a = 10^{17} \text{ cm}^{-3}$  and  $N_d = 10^{16} \text{ cm}^{-3}$ , as sketched below.



4a) (6 points) Compute the value of the electrostatic potential at  $x = 0$  in thermal equilibrium (numerical answer expected).

We can calculate this by integrating electric field starting from either side of the junction. Starting from the quasi-neutral n-side as below:

$$\phi(-) = \phi_n - \frac{qN_d x_{no}^2}{2\epsilon_s}$$

where  $x_{no}$  is the extent of the depletion region on the n side. This is given by:

$$x_{no} = \sqrt{\frac{2\epsilon_s \phi_B N_a}{q(N_a + N_d)N_d}}$$

We need:

$$\phi_n = 60 \times 6 = 360 \text{ mV}$$

$$\phi_B = \phi_n - \phi_p = 360 + 60 \times 7 = 0.78 \text{ V}$$

Then

$$\phi(-) = \phi_n - \frac{qN_d}{2\epsilon_s} \frac{2\epsilon_s \phi_B N_a}{q(N_a + N_d)N_d} = \phi_n - \frac{\phi_B N_a}{N_a + N_d} = 0.36 - \frac{0.78 \times 10^{17}}{1.1 \times 10^{17}} = -0.35 \text{ V}$$

4b) (4 points) Compute  $n_0$  and  $p_0$  at  $x = 0$  in thermal equilibrium (numerical answer expected).

Using the Boltzmann relation now:

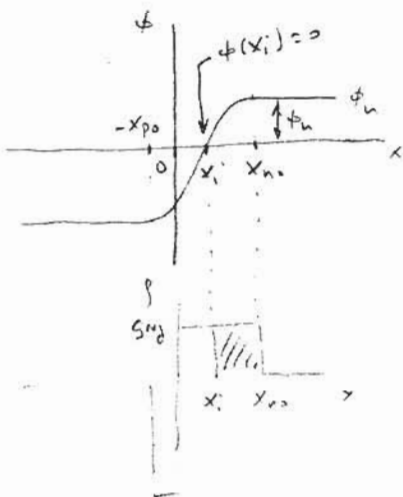
$$n_0(0) = n_i \exp\left(\frac{e\phi(0)}{kT}\right) = 10^{10} \exp\left(-\frac{0.35}{0.025}\right) = 8.3 \times 10^2 \text{ cm}^{-3}$$

$$p_0(0) = \frac{n_i^2}{n_0(0)} = \frac{10^{20}}{8.3 \times 10^2} = 1.2 \times 10^{16} \text{ cm}^{-3}$$

call it  $x_i$

4c) (5 points) Compute the value of  $x$  for which  $n_0 = p_0 = n_i$  in thermal equilibrium (numerical answer expected).

Since  $N_a > N_d$ , this point is to the right of the metallurgical junction, that is,  $x_i > 0$ . At  $x_i$ ,  $\phi(x_i) = 0$  by choice of potential reference. So we have to compute the extent of depletion region on the n side needed to drop a potential equal to  $\phi_n$ . Using simple electrostatics:



$$\frac{qN_a(x_{n0} - x_i)^2}{2\epsilon_s} = \phi_n$$

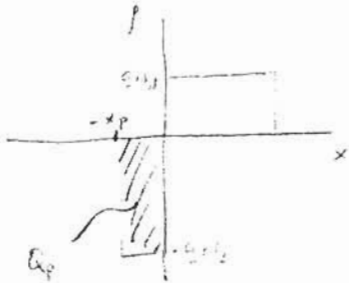
solving for  $x_i$ :

$$x_i = x_{n0} - \sqrt{\frac{2\epsilon_s \phi_n}{qN_a}} = \sqrt{\frac{2\epsilon_s \phi_n N_a}{q(N_a + N_d)N_d}} - \sqrt{\frac{2\epsilon_s \phi_n}{qN_d}} =$$

$$= \sqrt{\frac{2\epsilon_s}{qN_d}} \left( \sqrt{\frac{\phi_n N_a}{N_a + N_d}} - \sqrt{\phi_n} \right) = \sqrt{\frac{2 \times 1.05 \times 10^{-12}}{1.6 \times 10^{-19} \times 10^{16}}} \left( \sqrt{\frac{0.35 \times 10^{17}}{1.1 \times 10^{17}}} - \sqrt{0.35} \right) =$$

$$= 8.8 \times 10^{-6} \text{ cm} = 0.088 \mu\text{m}$$

4d) (5 points) Compute the total amount of charge per unit area on the p side of the junction when a reverse bias voltage of 5 V is applied to the diode (numerical answer with appropriate sign expected).



The total charge on the p-side of the diode is negative and is given by

$$Q_p = -q N_a x_p$$

$x_p$  is given by:

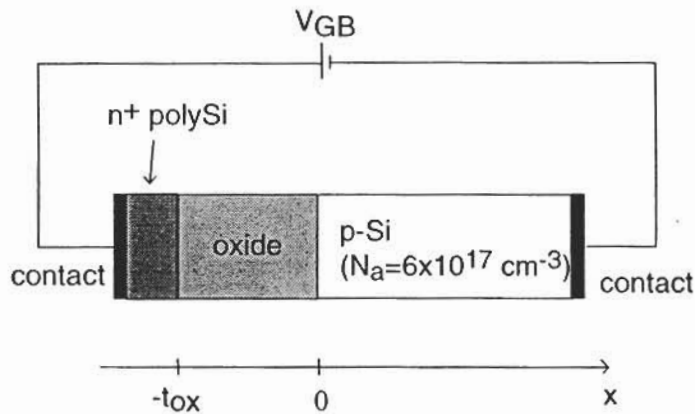
$$x_p = \sqrt{\frac{2\epsilon_s (\phi_0 - V) N_d}{q (N_a + N_d) N_a}}$$

Then

$$Q_p = - \sqrt{\frac{2q\epsilon_s (\phi_0 - V) N_d N_a}{N_a + N_d}} = - \sqrt{\frac{2 \times 1.6 \times 10^{-19} \times (0.78 + 5) \times 10^{16} \times 10^{17}}{1.1 \times 10^{17}}} = - 1.3 \times 10^{-7} \text{ C/cm}^2$$



5. (30 points) Consider the following MOS structure:



The oxide thickness is  $t_{ox} = 5 \text{ nm} = 5 \times 10^{-7} \text{ cm}$ . To save you time, for this structure:

$$\gamma = \frac{1}{C_{ox}} \sqrt{2\epsilon_s q N_a} = 0.65 \text{ V}^{1/2}$$

(5a) (5 points) Compute the threshold voltage of the structure (numerical answer with appropriate sign expected).

$$V_T = V_{FB} - 2\phi_p + \gamma \sqrt{-2\phi_p}$$

$$V_{FB} = -\phi_B = -\phi_{n+} + \phi_p = -0.55 - 0.47 = -1.02 \text{ V}$$

$$\phi_p = -\frac{kT}{q} \ln \frac{N_a}{n_i} = -0.026 \ln \frac{6 \times 10^{17}}{10^{10}} = -0.47 \text{ V}$$

Then

$$V_T = -1.02 + 2 \times 0.47 + 0.65 \sqrt{2 \times 0.47} = 0.55 \text{ V}$$

(5b) (5 points) What is the value of  $V_{GB}$  that leads to a sheet charge density in the inversion layer of  $Q_n = -10^{-6} \text{ C/cm}^2$ ? (numerical answer expected).

Use MOS charge control relation:

$$Q_n = -C_{ox} (V_{GB} - V_T)$$

$$C_{ox} = \frac{\epsilon_{ox}}{t_{ox}} = \frac{3.45 \times 10^{-13}}{5 \times 10^{-7}} = 6.9 \times 10^{-7} \text{ F/cm}^2$$

Then

$$V_{GB} = V_T - \frac{Q_n}{C_{ox}} = 0.55 + \frac{10^{-6}}{6.9 \times 10^{-7}} = 2 \text{ V}$$

(5c) (5 points) What is the magnitude of  $E_{ox}$  (electric field across the oxide) for a condition in which  $Q_G = -2 \times 10^{-7} \text{ C/cm}^2$ ? (numerical answer expected).

Use Gauss' law:

$$|E_{ox}| = \frac{Q_G}{\epsilon_{ox}} = + \frac{2 \times 10^{-7}}{3.45 \times 10^{-13}} = 5.8 \times 10^5 \text{ V/cm}$$

(5d) (5 points) What is the magnitude of  $E_s = E(x = 0^+)$  (electric field on semiconductor side of oxide-semiconductor interface) at threshold? (numerical answer expected).

At threshold

$$E_s = \frac{q N_a x_{dmax}}{\epsilon_s}$$

with  $x_{dmax}$  given by:

$$x_{dmax} = \sqrt{\frac{2\epsilon_s (-\phi_p)}{q N_a}}$$

Then

$$E_s = \sqrt{\frac{q N_a^2 (-\phi_p)}{\epsilon_s}} = \sqrt{\frac{1.6 \times 10^{-19} \times 6 \times 10^{17} \times 2 \times 2 \times 0.47}{1.05 \times 10^{-12}}} = 4.2 \times 10^5 \text{ V/cm}$$

(5e) (10 points) What is the capacitance of the MOS structure at a bias point for which the total charge in the semiconductor is equal to  $-2 \times 10^{-7} \text{ C/cm}^2$ ? (numerical answer expected).

To check regime, we need to compute  $Q_{Bmax} = q N_a x_{dmax}$ . That is given by

$$|Q_{Bmax}| = \epsilon_s E_s(0) \Big|_{\text{threshold}} = 1.05 \times 10^{-12} \times 4.2 \times 10^5 = 4.4 \times 10^{-7} \text{ C/cm}^2$$

Since this is bigger than  $-2 \times 10^{-7}$ , structure is in depletion

Thickness of depletion region is:

$$x_d = \frac{|Q_B|}{q N_a} = \frac{2 \times 10^{-7}}{1.6 \times 10^{-19} \times 6 \times 10^{17}} = 2.1 \times 10^{-6} \text{ cm}$$

Capacitance is then:

$$C = \frac{1}{\frac{t_{ox}}{\epsilon_{ox}} + \frac{x_d}{\epsilon_s}} = \frac{1}{\frac{5 \times 10^{-7}}{3.45 \times 10^{-13}} + \frac{2.1 \times 10^{-6}}{1.05 \times 10^{-12}}} = 2.9 \times 10^{-7} \text{ F/cm}^2$$

6. (20 points) Consider a MOSFET made out of the MOS structure of problem 5. The gate length is  $L = 1 \mu\text{m}$ . The gate width is  $W = 10 \mu\text{m}$ . The electron mobility in the channel is  $200 \text{ cm}^2/\text{V} \cdot \text{s}$ .

The MOSFET is biased with  $V_{DS} = 0.1 \text{ V}$ ,  $V_{GS} = 1 \text{ V}$  and  $V_{BS} = 0 \text{ V}$ . If you did not compute the threshold voltage of this structure in section (5a), assume it to be  $0.5 \text{ V}$ .

(6a) (10 points) Compute the magnitude of the inversion layer charge density at the source-end of the channel:  $|Q_n(y=0)|$  (numerical answer expected).

This MOSFET is in the linear regime.

At the source, the inversion layer charge is simply given by:

$$\begin{aligned} |Q_n(y=0)| &= C_{ox} (V_{GS} - V_T) = 6.9 \times 10^{-7} (1 - 0.55) = \\ &= 3.1 \times 10^{-7} \text{ C/cm}^2 \end{aligned}$$

(6b) (10 points) Compute the magnitude of the electron velocity at the source-end of the channel:  $|v_y(y=0)|$  (numerical answer expected).

Compute current first:

$$\begin{aligned} I_D &= \frac{W}{L} \mu_n C_{ox} \left( V_{GS} - \frac{V_{DS}}{2} - V_T \right) V_{DS} \\ &= \frac{10}{1} \times 200 \times 6.9 \times 10^{-7} (1 - 0.05 - 0.55) \times 0.1 = 55 \mu\text{A} \end{aligned}$$

Now, the current is equal to the charge times the velocity times the width at the source:

$$I_D = W |Q_n(y=0)| v_y(y=0)$$

Then

$$v_y(y=0) = \frac{I_D}{W |Q_n(y=0)|} = \frac{55 \times 10^{-6}}{10 \times 10^{-4} \times 3.1 \times 10^{-7}} = 1.8 \times 10^5 \text{ cm/s}$$